The S-82G1B Series is a protection IC for lithium-ion / lithium polymer rechargeable batteries, which includes high-accuracy voltage detection circuits and delay circuits. It is suitable for protecting 1-cell lithium-ion / lithium polymer rechargeable battery packs from overcharge, overdischarge, and overcurrent.

Using the S-82G1B Series makes it possible to configure a protection circuit which separates the charge and discharge current paths.

Independent charge current path suppresses heat generation during charging.

### Features

- **High-accuracy voltage detection circuit**
  - Overcharge detection voltage: 3.500 V to 4.600 V (5 mV step) Accuracy ±15 mV
  - Overcharge release voltage: 3.100 V to 4.600 V\(^1\) Accuracy ±50 mV
  - Overdischarge detection voltage: 2.000 V to 3.000 V (10 mV step) Accuracy ±50 mV
  - Overdischarge release voltage: 2.000 V to 3.400 V\(^2\) Accuracy ±75 mV
  - Discharge overcurrent detection voltage 1: 0.003 V to 0.100 V (0.5 mV step) Accuracy ±1.5 mV
  - Discharge overcurrent detection voltage 2: 0.010 V to 0.100 V (1 mV step) Accuracy ±3 mV
  - Load short-circuiting detection voltage: 0.020 V to 0.100 V (1 mV step) Accuracy ±5 mV
  - Charge overcurrent detection voltage: −0.100 V to 0.010 V (1 mV step) Accuracy ±3 mV

- **Detection delay times** are generated only by an internal circuit (external capacitors are unnecessary).

- **Discharge overcurrent control function**
  - Load short-circuiting detection 2 function is selectable: Available, unavailable
  - Release condition of discharge overcurrent status: Load disconnection
  - Release voltage of discharge overcurrent status: \( V_{RIOV} = VDD \times 0.8 \)

- **0 V battery charge function** is selectable: Available, unavailable
- **Power-down function** is selectable: Available, unavailable
- **High-withstand voltage**: VMC pin, VMD pin and CO pin: Absolute maximum rating 28 V
- **Wide operation temperature range**: \( Ta = -40°C \) to \(+85°C\)
- **Low current consumption**
  - During operation: 2.0 \( \mu \)A typ., 4.0 \( \mu \)A max. (\( Ta = +25°C\))
  - During power-down: 50 nA max. (\( Ta = +25°C\))
  - During overdischarge: 0.5 \( \mu \)A max. (\( Ta = +25°C\))
- **Lead-free (Sn 100%), halogen-free**

\(^1\) Overcharge release voltage = Overcharge detection voltage − Overcharge hysteresis voltage
(Overcharge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.4 V in 50 mV step.)

\(^2\) Overdischarge release voltage = Overdischarge detection voltage + Overdischarge hysteresis voltage
(Overdischarge hysteresis voltage can be selected as 0 V or from a range of 0.1 V to 0.7 V in 100 mV step.)

### Applications

- Lithium-ion rechargeable battery pack
- Lithium polymer rechargeable battery pack

### Package

- HSNT-8(1616)
### Block Diagram

- **VDD**: Power supply input
- **VSS**: Ground
- **VINI**: Input voltage control
- **VMD**: Middle voltage control
- **VMC**: Control voltage input
- **DO**: Output discharge
- **CO**: Output charge

- **Overdischarge detection comparator**
- **Overcharge detection comparator**
- **Discharge overcurrent detection 1 comparator**
- **Discharge overcurrent detection 2 comparator**
- **Load short-circuiting detection comparator**
- **Charge overcurrent detection comparator**

**Figure 1**
PRODUCT NAME STRUCTURE

1. Product name

S-82G1B xx - A8T2 U

- Environmental code
  U: Lead-free (Sn 100%), halogen-free

- Package abbreviation and IC packing specifications
  A8T2: HSNT-8(1616), Tape

- Serial code
  Sequentially set from AA to ZZ

*1. Refer to the tape drawing.

2. Package

Table 1 Package Drawing Codes

<table>
<thead>
<tr>
<th>Package Name</th>
<th>Dimension</th>
<th>Tape</th>
<th>Reel</th>
<th>Land</th>
</tr>
</thead>
<tbody>
<tr>
<td>HSNT-8(1616)</td>
<td>PY008-A-P-SD</td>
<td>PY008-A-C-SD</td>
<td>PY008-A-R-SD</td>
<td>PY008-A-L-SD</td>
</tr>
</tbody>
</table>
3. Product name list

<table>
<thead>
<tr>
<th>Product Name</th>
<th>Overcharge Detection Voltage [V_{CU}]</th>
<th>Overcharge Release Voltage [V_{CL}]</th>
<th>Overdischarge Detection Voltage [V_{DL}]</th>
<th>Overdischarge Release Voltage [V_{DU}]</th>
<th>Discharge Overcurrent Detection Voltage 1 [V_{DIOV1}]</th>
<th>Discharge Overcurrent Detection Voltage 2 [V_{DIOV2}]</th>
<th>Load Short-circuiting Detection Voltage [V_{SHORT}]</th>
<th>Charge Overcurrent Detection Voltage [V_{COV}]</th>
</tr>
</thead>
<tbody>
<tr>
<td>S-82G1BAA-A8T2U</td>
<td>4.500 V</td>
<td>4.350 V</td>
<td>2.100 V</td>
<td>2.300 V</td>
<td>0.014 V</td>
<td>0.020 V</td>
<td>0.068 V</td>
<td>-0.029 V</td>
</tr>
</tbody>
</table>

Table 2 (1 / 2)

<table>
<thead>
<tr>
<th>Product Name</th>
<th>Delay Time Combination*1</th>
<th>Load Short-circuiting Detection 2 Function*2</th>
<th>0 V Battery Charge Function*3</th>
<th>Power-down Function*4</th>
</tr>
</thead>
<tbody>
<tr>
<td>S-82G1BAA-A8T2U</td>
<td>(1)</td>
<td>Available</td>
<td>Available</td>
<td>Unavailable</td>
</tr>
</tbody>
</table>

*1. Refer to Table 3 about the details of the delay time combinations.

*2. Load short-circuiting detection 2 function "available" / "unavailable" is selectable.

*3. 0 V battery charge function "available" / "unavailable" is selectable.

*4. Power-down function "available" / "unavailable" is selectable.

Remark  Please contact our sales office for products other than the above.

Table 3

<table>
<thead>
<tr>
<th>Delay Time Combination</th>
<th>Overcharge Detection Delay Time [t_{CU}]</th>
<th>Overdischarge Detection Delay Time [t_{DL}]</th>
<th>Discharge Overcurrent Detection Delay Time 1 [t_{DIOV1}]</th>
<th>Discharge Overcurrent Detection Delay Time 2 [t_{DIOV2}]</th>
<th>Load Short-circuiting Detection Delay Time [t_{SHORT}]</th>
<th>Charge Overcurrent Detection Delay Time [t_{COV}]</th>
</tr>
</thead>
<tbody>
<tr>
<td>(1)</td>
<td>1.0 s</td>
<td>64 ms</td>
<td>3.75 s</td>
<td>16 ms</td>
<td>280 μs</td>
<td>32 ms</td>
</tr>
</tbody>
</table>

Remark  The delay times can be changed within the range listed in Table 4. For details, please contact our sales office.

Table 4

<table>
<thead>
<tr>
<th>Delay Time</th>
<th>Symbol</th>
<th>Selection Range</th>
<th>Remark</th>
</tr>
</thead>
<tbody>
<tr>
<td>Overcharge detection delay time</td>
<td>t_{CU}</td>
<td>256 ms, 512 ms, 1.0 s</td>
<td>Select a value from the left.</td>
</tr>
<tr>
<td>Overdischarge detection delay time</td>
<td>t_{DL}</td>
<td>32 ms, 64 ms, 128 ms</td>
<td>Select a value from the left.</td>
</tr>
<tr>
<td>Discharge overcurrent detection delay time 1</td>
<td>t_{DIOV1}</td>
<td>8 ms, 16 ms, 32 ms, 64 ms, 128 ms, 256 ms</td>
<td>Select a value from the left.</td>
</tr>
<tr>
<td>Discharge overcurrent detection delay time 2</td>
<td>t_{DIOV2}</td>
<td>4 ms, 8 ms, 16 ms, 32 ms, 64 ms, 128 ms</td>
<td>Select a value from the left.</td>
</tr>
<tr>
<td>Load short-circuiting detection delay time</td>
<td>t_{SHORT}</td>
<td>280 μs, 530 μs</td>
<td>Select a value from the left.</td>
</tr>
<tr>
<td>Charge overcurrent detection delay time</td>
<td>t_{COV}</td>
<td>4 ms, 8 ms, 16 ms, 32 ms, 64 ms, 128 ms</td>
<td>Select a value from the left.</td>
</tr>
</tbody>
</table>
■ Pin Configuration

1. HSNT-8(1616)

Table 5

<table>
<thead>
<tr>
<th>Pin No.</th>
<th>Symbol</th>
<th>Description</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>VMD</td>
<td>Load monitoring pin</td>
</tr>
<tr>
<td>2</td>
<td>VMC</td>
<td>Negative power supply pin for charge control</td>
</tr>
<tr>
<td>3</td>
<td>CO</td>
<td>Connection pin of charge control FET gate (CMOS output)</td>
</tr>
<tr>
<td>4</td>
<td>DO</td>
<td>Connection pin of discharge control FET gate (CMOS output)</td>
</tr>
<tr>
<td>5</td>
<td>VSS</td>
<td>Input pin for negative power supply</td>
</tr>
<tr>
<td>6</td>
<td>VDD</td>
<td>Input pin for positive power supply</td>
</tr>
<tr>
<td>7</td>
<td>VINI</td>
<td>Discharge overcurrent detection pin</td>
</tr>
<tr>
<td>8</td>
<td>NC(^2)</td>
<td>No connection</td>
</tr>
</tbody>
</table>

\(^1\). Connect the heat sink of backside at shadowed area to the board, and set electric potential open or \(V_{DD}\). However, do not use it as the function of electrode.

\(^2\). The NC pin is electrically open. The NC pin can be connected to VDD pin or VSS pin.
## Absolute Maximum Ratings

Table 6

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Applied Pin</th>
<th>Absolute Maximum Rating</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input voltage between VDD pin and VSS pin</td>
<td>VDS</td>
<td>VDD</td>
<td>V_{SS} - 0.3 to V_{SS} + 6</td>
<td>V</td>
</tr>
<tr>
<td>VINI pin input voltage</td>
<td>VINI</td>
<td>VINI</td>
<td>VDD - 6 to VDD + 0.3</td>
<td>V</td>
</tr>
<tr>
<td>VMC pin input voltage</td>
<td>VVMC</td>
<td>VMC</td>
<td>VDD - 28 to VDD + 0.3</td>
<td>V</td>
</tr>
<tr>
<td>VMD pin input voltage</td>
<td>VVMD</td>
<td>VMD</td>
<td>VDD - 28 to VDD + 0.3</td>
<td>V</td>
</tr>
<tr>
<td>DO pin output voltage</td>
<td>VDO</td>
<td>DO</td>
<td>VSS - 0.3 to VDD + 0.3</td>
<td>V</td>
</tr>
<tr>
<td>CO pin output voltage</td>
<td>VCO</td>
<td>CO</td>
<td>VDD - 28 to VDD + 0.3</td>
<td>V</td>
</tr>
<tr>
<td>Operation ambient temperature</td>
<td>T_{op}</td>
<td>–</td>
<td>−40 to +85</td>
<td>°C</td>
</tr>
<tr>
<td>Storage temperature</td>
<td>T_{stg}</td>
<td>–</td>
<td>−55 to +125</td>
<td>°C</td>
</tr>
</tbody>
</table>

Caution  The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

## Thermal Resistance Value

Table 7

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Junction-to-ambient thermal resistance</td>
<td>θ_{JA}</td>
<td>HSNT-8(1616)</td>
<td>Board A</td>
<td>–</td>
<td>214</td>
<td>°C/W</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Board B</td>
<td>–</td>
<td>172</td>
<td>°C/W</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Board C</td>
<td>–</td>
<td>–</td>
<td>°C/W</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Board D</td>
<td>–</td>
<td>–</td>
<td>°C/W</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>Board E</td>
<td>–</td>
<td>–</td>
<td>°C/W</td>
</tr>
</tbody>
</table>

*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark  Refer to "Power Dissipation" and "Test Board" for details.
### Electrical Characteristics

1. \( Ta = +25^\circ C \)

#### Table 8

(Ta = +25°C unless otherwise specified)

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
<th>Test Circuit</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>Detection Voltage</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Overcharge detection voltage</td>
<td>( V_{CU} )</td>
<td>( V_{CL} \neq V_{CU} )</td>
<td>( V_{CL} - 0.050 )</td>
<td>( V_{CL} )</td>
<td>( V_{CL} + 0.050 )</td>
<td>V</td>
<td>1</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( V_{CL} = V_{CU} )</td>
<td>( V_{CL} - 0.020 )</td>
<td>( V_{CL} )</td>
<td>( V_{CL} + 0.015 )</td>
<td>V</td>
<td>1</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Overcharge release voltage</td>
<td>( V_{CL} )</td>
<td>( V_{CL} - 0.050 )</td>
<td>( V_{CL} )</td>
<td>( V_{CL} + 0.050 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Overdischarge detection voltage</td>
<td>( V_{DL} )</td>
<td>( V_{DL} - 0.075 )</td>
<td>( V_{DL} )</td>
<td>( V_{DL} + 0.050 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Overdischarge release voltage</td>
<td>( V_{DU} )</td>
<td>( V_{DU} - 0.050 )</td>
<td>( V_{DU} )</td>
<td>( V_{DU} + 0.050 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Discharge overcurrent detection voltage 1</td>
<td>( V_{DIOV1} )</td>
<td>( V_{DIOV1} - 0.015 )</td>
<td>( V_{DIOV1} )</td>
<td>( V_{DIOV1} + 0.015 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Discharge overcurrent detection voltage 2</td>
<td>( V_{DIOV2} )</td>
<td>( V_{DIOV2} - 0.003 )</td>
<td>( V_{DIOV2} )</td>
<td>( V_{DIOV2} + 0.003 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Load short-circuiting detection voltage</td>
<td>( V_{SHORT} )</td>
<td>( V_{SHORT} - 0.050 )</td>
<td>( V_{SHORT} )</td>
<td>( V_{SHORT} + 0.005 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Load short-circuiting detection voltage 2</td>
<td>( V_{SHORT2} )</td>
<td>( V_{DD} - 1.2 )</td>
<td>( V_{DD} - 0.8 )</td>
<td>( V_{DD} - 0.5 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Charge overcurrent detection voltage</td>
<td>( V_{COV} )</td>
<td>( V_{COV} - 0.030 )</td>
<td>( V_{COV} )</td>
<td>( V_{COV} + 0.003 )</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>Discharge overcurrent release voltage</td>
<td>( V_{RIOV} )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 0.77 )</td>
<td>( V_{DD} \times 0.80 )</td>
</tr>
<tr>
<td><strong>0 V Battery Charge Function</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>0 V battery charge starting charger voltage</td>
<td>( V_{CH} )</td>
<td>0 V battery charge function &quot;available&quot;</td>
<td>0.7</td>
<td>1.3</td>
<td>1.7</td>
<td>V</td>
<td>4</td>
</tr>
<tr>
<td>0 V battery charge inhibition battery voltage</td>
<td>( V_{NH} )</td>
<td>0 V battery charge function &quot;unavailable&quot;</td>
<td>0.9</td>
<td>1.2</td>
<td>1.5</td>
<td>V</td>
<td>2</td>
</tr>
<tr>
<td><strong>Internal Resistance</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Resistance between VDD pin and VMC pin</td>
<td>( R_{VMCD} )</td>
<td>( V_{DD} = 1.8 \ V, \ V_{VMC} = 0 \ V )</td>
<td>500</td>
<td>1250</td>
<td>2500</td>
<td>kΩ</td>
<td>3</td>
</tr>
<tr>
<td>Resistance between VDD pin and VMD pin</td>
<td>( R_{VMDD} )</td>
<td>( V_{DD} = 1.8 \ V, \ V_{VMD} = 0 \ V )</td>
<td>500</td>
<td>1250</td>
<td>2500</td>
<td>kΩ</td>
<td>3</td>
</tr>
<tr>
<td>Resistance between VMD pin and VSS pin</td>
<td>( R_{VMDS} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMD} = 1.0 \ V )</td>
<td>5</td>
<td>10</td>
<td>15</td>
<td>kΩ</td>
<td>3</td>
</tr>
<tr>
<td><strong>Input Voltage</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Operation voltage between VDD pin and VSS pin</td>
<td>( V_{DDP1} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMC} = 0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 2.0 )</td>
<td>( V_{DD} \times 4.0 )</td>
<td>μA</td>
<td>3</td>
</tr>
<tr>
<td>Operation voltage between VDD pin and VMC pin, VMD pin</td>
<td>( V_{DDP2} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMC} = 1.0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 0.05 )</td>
<td>( V_{DD} \times 0.5 )</td>
<td>μA</td>
<td>3</td>
</tr>
<tr>
<td><strong>Input Current</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Current consumption during operation</td>
<td>( I_{PE} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMC} = 0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 2.0 )</td>
<td>( V_{DD} \times 4.0 )</td>
<td>μA</td>
<td>3</td>
</tr>
<tr>
<td>Current consumption during power-down</td>
<td>( I_{PN} )</td>
<td>( V_{DD} = 0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 0.05 )</td>
<td>( V_{DD} \times 0.5 )</td>
<td>μA</td>
<td>3</td>
</tr>
<tr>
<td>Current consumption during overdischarge</td>
<td>( I_{PED} )</td>
<td>( V_{DD} = 1.5 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 0.05 )</td>
<td>( V_{DD} \times 0.5 )</td>
<td>μA</td>
<td>3</td>
</tr>
<tr>
<td><strong>Output Resistance</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>CO pin resistance &quot;H&quot;</td>
<td>( R_{CH} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMC} = 0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 10 )</td>
<td>( V_{DD} \times 20 )</td>
<td>kΩ</td>
<td>4</td>
</tr>
<tr>
<td>CO pin resistance &quot;L&quot;</td>
<td>( R_{CL} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMC} = 0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 10 )</td>
<td>( V_{DD} \times 20 )</td>
<td>kΩ</td>
<td>4</td>
</tr>
<tr>
<td>DO pin resistance &quot;H&quot;</td>
<td>( R_{DH} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMC} = 0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 10 )</td>
<td>( V_{DD} \times 20 )</td>
<td>kΩ</td>
<td>4</td>
</tr>
<tr>
<td>DO pin resistance &quot;L&quot;</td>
<td>( R_{DL} )</td>
<td>( V_{DD} = 3.4 \ V, \ V_{VMC} = 0 \ V )</td>
<td>( V_{DD} )</td>
<td>( V_{DD} \times 10 )</td>
<td>( V_{DD} \times 20 )</td>
<td>kΩ</td>
<td>4</td>
</tr>
<tr>
<td><strong>Delay Time</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Overcharge detection delay time</td>
<td>( t_{CU} )</td>
<td>( t_{CU} \times 0.7 )</td>
<td>( t_{CU} )</td>
<td>( t_{CU} \times 1.3 )</td>
<td>( t_{CU} \times 1.3 )</td>
<td>–</td>
<td>5</td>
</tr>
<tr>
<td>Overdischarge detection delay time</td>
<td>( t_{DL} )</td>
<td>( t_{DL} \times 0.7 )</td>
<td>( t_{DL} )</td>
<td>( t_{DL} \times 1.3 )</td>
<td>( t_{DL} \times 1.3 )</td>
<td>–</td>
<td>5</td>
</tr>
<tr>
<td>Discharge overcurrent detection delay time 1</td>
<td>( t_{DIOV1} )</td>
<td>( t_{DIOV1} \times 0.75 )</td>
<td>( t_{DIOV1} )</td>
<td>( t_{DIOV1} \times 1.25 )</td>
<td>( t_{DIOV1} \times 1.25 )</td>
<td>–</td>
<td>5</td>
</tr>
<tr>
<td>Discharge overcurrent detection delay time 2</td>
<td>( t_{DIOV2} )</td>
<td>( t_{DIOV2} \times 0.7 )</td>
<td>( t_{DIOV2} )</td>
<td>( t_{DIOV2} \times 1.3 )</td>
<td>( t_{DIOV2} \times 1.3 )</td>
<td>–</td>
<td>5</td>
</tr>
<tr>
<td>Load short-circuiting detection delay time</td>
<td>( t_{SHORT} )</td>
<td>( t_{SHORT} \times 0.7 )</td>
<td>( t_{SHORT} )</td>
<td>( t_{SHORT} \times 1.3 )</td>
<td>( t_{SHORT} \times 1.3 )</td>
<td>–</td>
<td>5</td>
</tr>
</tbody>
</table>

*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.*
<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
<th>Test Circuit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Overcharge detection voltage</td>
<td>$V_{CU}$</td>
<td>$V_{CU}$ - $V_{CU}$ - $0.045$</td>
<td>$V_{CU}$</td>
<td>$V_{CU}$ + $0.030$</td>
<td>$V_{CU}$</td>
<td>V</td>
<td>1</td>
</tr>
<tr>
<td>Overcharge release voltage</td>
<td>$V_{CL}$</td>
<td>$V_{CL}$ ≠ $V_{CU}$</td>
<td>$V_{CL}$ - $0.080$</td>
<td>$V_{CL}$</td>
<td>$V_{CL}$ + $0.060$</td>
<td>$V_{CL}$</td>
<td>V</td>
</tr>
<tr>
<td>Overdischarge detection voltage</td>
<td>$V_{DL}$</td>
<td>$V_{DL}$ - $V_{DL}$ - $0.080$</td>
<td>$V_{DL}$</td>
<td>$V_{DL}$ + $0.060$</td>
<td>$V_{DL}$</td>
<td>V</td>
<td>1</td>
</tr>
<tr>
<td>Overdischarge release voltage</td>
<td>$V_{DU}$</td>
<td>$V_{DU}$ ≠ $V_{DU}$</td>
<td>$V_{DU}$ - $0.105$</td>
<td>$V_{DU}$</td>
<td>$V_{DU}$ + $0.085$</td>
<td>$V_{DU}$</td>
<td>V</td>
</tr>
<tr>
<td>Discharge overcurrent detection voltage 1</td>
<td>$V_{DIOV1}$</td>
<td>$V_{DIOV1}$ - $0.002$</td>
<td>$V_{DIOV1}$</td>
<td>$V_{DIOV1}$ + $0.002$</td>
<td>$V_{DIOV1}$</td>
<td>V</td>
<td>5</td>
</tr>
<tr>
<td>Discharge overcurrent detection voltage 2</td>
<td>$V_{DIOV2}$</td>
<td>$V_{DIOV2}$ - $0.003$</td>
<td>$V_{DIOV2}$</td>
<td>$V_{DIOV2}$ + $0.003$</td>
<td>$V_{DIOV2}$</td>
<td>V</td>
<td>2</td>
</tr>
<tr>
<td>Load short-circuiting detection voltage</td>
<td>$V_{SHORT}$</td>
<td>$V_{SHORT}$ - $0.005$</td>
<td>$V_{SHORT}$</td>
<td>$V_{SHORT}$ + $0.005$</td>
<td>$V_{SHORT}$</td>
<td>V</td>
<td>2</td>
</tr>
<tr>
<td>Load short-circuiting detection voltage 2</td>
<td>$V_{SHORT2}$</td>
<td>$V_{DD}$ - $1.4$</td>
<td>$V_{DD}$ - $0.8$</td>
<td>$V_{DD}$ - $0.3$</td>
<td>$V_{DD}$</td>
<td>V</td>
<td>2</td>
</tr>
<tr>
<td>Charge overcurrent detection voltage</td>
<td>$V_{CIOV}$</td>
<td>$V_{CIOV}$ - $0.003$</td>
<td>$V_{CIOV}$</td>
<td>$V_{CIOV}$ + $0.003$</td>
<td>$V_{CIOV}$</td>
<td>V</td>
<td>2</td>
</tr>
<tr>
<td>Discharge overcurrent release voltage</td>
<td>$V_{RIOV}$</td>
<td>$V_{DD}$</td>
<td>$V_{DD}$</td>
<td>$0.77$</td>
<td>$V_{DD}$</td>
<td>V</td>
<td>5</td>
</tr>
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</table>

**0 V Battery Charge Function**

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>0 V battery charge starting charger voltage</td>
<td>$V_{0CHA}$</td>
<td>0 V battery charge function &quot;available&quot;</td>
<td>0.5</td>
<td>1.3</td>
<td>1.9</td>
<td>V</td>
</tr>
<tr>
<td>0 V battery charge inhibition battery voltage</td>
<td>$V_{0NH}$</td>
<td>0 V battery charge function &quot;unavailable&quot;</td>
<td>0.7</td>
<td>1.2</td>
<td>1.7</td>
<td>V</td>
</tr>
</tbody>
</table>

**Internal Resistance**

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Resistance between VDD pin and VMC pin</td>
<td>$R_{VMCD}$</td>
<td>$V_{DD}$ = 1.8 V, $V_{VMC}$ = 0 V</td>
<td>250</td>
<td>1250</td>
<td>3500</td>
<td>kΩ</td>
</tr>
<tr>
<td>Resistance between VDD pin and VMD pin</td>
<td>$R_{VMDD}$</td>
<td>$V_{DD}$ = 1.8 V, $V_{VMD}$ = 0 V</td>
<td>250</td>
<td>1250</td>
<td>3500</td>
<td>kΩ</td>
</tr>
<tr>
<td>Resistance between VMD pin and VSS pin</td>
<td>$R_{VMD}$</td>
<td>$V_{DD}$ = 3.4 V, $V_{VMD}$ = 1.0 V</td>
<td>3.5</td>
<td>10</td>
<td>20</td>
<td>kΩ</td>
</tr>
</tbody>
</table>

**Input Voltage**

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Operation voltage between VDD pin and VSS pin</td>
<td>$V_{DSOP1}$</td>
<td>–</td>
<td>1.5</td>
<td>–</td>
<td>6.0</td>
<td>V</td>
</tr>
<tr>
<td>Operation voltage between VDD pin and VMC pin, VMD pin</td>
<td>$V_{DSOP2}$</td>
<td>–</td>
<td>1.5</td>
<td>–</td>
<td>28</td>
<td>V</td>
</tr>
</tbody>
</table>

**Input Current**

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Current consumption during operation</td>
<td>$I_{OPE}$</td>
<td>$V_{DD}$ = 3.4 V, $V_{VMC}$ = $V_{VMD}$ = 0 V</td>
<td>–</td>
<td>2.0</td>
<td>5.0</td>
<td>μA</td>
</tr>
<tr>
<td>Current consumption during power-down</td>
<td>$I_{PDN}$</td>
<td>$V_{DD}$ = $V_{VMC}$ = $V_{VMD}$ = 1.5 V</td>
<td>–</td>
<td>–</td>
<td>0.1</td>
<td>μA</td>
</tr>
<tr>
<td>Current consumption during overdischarge</td>
<td>$I_{OPED}$</td>
<td>$V_{DD}$ = $V_{VMC}$ = $V_{VMD}$ = 1.5 V</td>
<td>–</td>
<td>–</td>
<td>1.0</td>
<td>μA</td>
</tr>
</tbody>
</table>

**Output Resistance**

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>CO pin resistance &quot;H&quot;</td>
<td>$R_{COH}$</td>
<td>–</td>
<td>2.5</td>
<td>10</td>
<td>30</td>
<td>kΩ</td>
</tr>
<tr>
<td>CO pin resistance &quot;L&quot;</td>
<td>$R_{COL}$</td>
<td>–</td>
<td>2.5</td>
<td>10</td>
<td>30</td>
<td>kΩ</td>
</tr>
<tr>
<td>DO pin resistance &quot;H&quot;</td>
<td>$R_{DOH}$</td>
<td>–</td>
<td>2.5</td>
<td>10</td>
<td>30</td>
<td>kΩ</td>
</tr>
<tr>
<td>DO pin resistance &quot;L&quot;</td>
<td>$R_{DOL}$</td>
<td>–</td>
<td>0.5</td>
<td>2</td>
<td>6</td>
<td>kΩ</td>
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</tbody>
</table>

**Delay Time**

<table>
<thead>
<tr>
<th>Item</th>
<th>Symbol</th>
<th>Condition</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Unit</th>
</tr>
</thead>
<tbody>
<tr>
<td>Overcharge detection delay time</td>
<td>$t_{CU}$</td>
<td>–</td>
<td>$t_{CU} \times 0.4$</td>
<td>$t_{CU}$</td>
<td>$t_{CU} \times 1.6$</td>
<td>–</td>
</tr>
<tr>
<td>Overdischarge detection delay time</td>
<td>$t_{DL}$</td>
<td>–</td>
<td>$t_{DL} \times 0.4$</td>
<td>$t_{DL}$</td>
<td>$t_{DL} \times 1.6$</td>
<td>–</td>
</tr>
<tr>
<td>Discharge overcurrent detection delay time 1</td>
<td>$t_{DIOV1}$</td>
<td>–</td>
<td>$t_{DIOV1} \times 0.4$</td>
<td>$t_{DIOV1}$</td>
<td>$t_{DIOV1} \times 1.6$</td>
<td>–</td>
</tr>
<tr>
<td>Discharge overcurrent detection delay time 2</td>
<td>$t_{DIOV2}$</td>
<td>–</td>
<td>$t_{DIOV2} \times 0.4$</td>
<td>$t_{DIOV2}$</td>
<td>$t_{DIOV2} \times 1.6$</td>
<td>–</td>
</tr>
<tr>
<td>Load short-circuiting detection delay time</td>
<td>$t_{SHORT}$</td>
<td>–</td>
<td>$t_{SHORT} \times 0.4$</td>
<td>$t_{SHORT}$</td>
<td>$t_{SHORT} \times 1.6$</td>
<td>–</td>
</tr>
<tr>
<td>Charge overcurrent detection delay time</td>
<td>$t_{CIOV}$</td>
<td>–</td>
<td>$t_{CIOV} \times 0.4$</td>
<td>$t_{CIOV}$</td>
<td>$t_{CIOV} \times 1.6$</td>
<td>–</td>
</tr>
</tbody>
</table>

*1. Since products are not screened at high and low temperature, the specification for this temperature range is guaranteed by design, not tested in production.
Test Circuits

Caution Unless otherwise specified, the output voltage levels "H" and "L" at CO pin (VCO) and DO pin (VDO) are judged by the threshold voltage (1.0 V) of the N-channel FET. Judge the CO pin level with respect to VVMC and the DO pin level with respect to VSS.

1. Overcharge detection voltage, overcharge release voltage (Test circuit 1)

Overcharge detection voltage (VCU) is defined as the voltage V1 at which VCO goes from "H" to "L" when the voltage V1 is gradually increased after setting V1 = 3.4 V. Overcharge release voltage (VCL) is defined as the voltage V1 at which VCO goes from "L" to "H" when the voltage V1 is then gradually decreased. Overcharge hysteresis voltage (VHC) is defined as the difference between VCU and VCL.

2. Overdischarge detection voltage, overdischarge release voltage (Test circuit 2)

Overdischarge detection voltage (VDL) is defined as the voltage V1 at which VDO goes from "H" to "L" when the voltage V1 is gradually decreased after setting V1 = 3.4 V, V2 = V5 = V6 = 0 V. Overdischarge release voltage (VDU) is defined as the voltage V1 at which VDO goes from "L" to "H" when setting V2 = 0.01 V, V5 = V6 = 0 V and when the voltage V1 is then gradually increased. Overdischarge hysteresis voltage (VHD) is defined as the difference between VDU and VDL.

3. Discharge overcurrent detection voltage 1, discharge overcurrent release voltage (Test circuit 5)

Discharge overcurrent detection voltage 1 (VDIOV1) is defined as the voltage V5 whose delay time for changing VDO from "H" to "L" is discharge overcurrent detection delay time 1 (tDIOV1) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = V5 = 0 V, V6 = 1.4 V. Discharge overcurrent release voltage (VRIOV) is defined as the voltage V6 at which VDO goes from "L" to "H" when setting V5 = 0 V, V6 = 3.4 V and when the voltage V6 is then gradually decreased.

When the voltage V6 falls below VRIOV, VDO will go to "H" after 1.0 ms typ. and maintain "H" during load short-circuiting detection delay time (tSHORT).

4. Discharge overcurrent detection voltage 2 (Test circuit 2)

Discharge overcurrent detection voltage 2 (VDIOV2) is defined as the voltage V5 whose delay time for changing VDO from "H" to "L" is discharge overcurrent detection delay time 2 (tDIOV2) when the voltage V5 is increased after setting V1 = 3.4 V, V2 = V5 = 0 V, V6 = 1.4 V.

5. Load short-circuiting detection voltage (Test circuit 2)

Load short-circuiting detection voltage (VSHORT) is defined as the voltage V5 whose delay time for changing VDO from "H" to "L" is tSHORT when the voltage V5 is increased after setting V1 = 3.4 V, V2 = V5 = 0 V, V6 = 1.4 V.

6. Load short-circuiting detection voltage 2 (Test circuit 2)

Load short-circuiting detection voltage 2 (VSHORT2) is defined as the voltage V6 whose delay time for changing VDO from "H" to "L" is tSHORT when the voltage V6 is increased after setting V1 = 3.4 V, V2 = V5 = V6 = 0 V.
7. Charge overcurrent detection voltage
   (Test circuit 2)
   Charge overcurrent detection voltage ($V_{CIOV}$) is defined as the voltage $V2$ whose delay time for changing $V_{CO}$ from "H" to "L" is charge overcurrent detection delay time ($t_{CIOV}$) when the voltage $V2$ is decreased after setting $V1 = 3.4$ V, $V2 = V5 = V6 = 0$ V.

8. Current consumption during operation
   (Test circuit 3)
   The current consumption during operation ($I_{OPE}$) is the current that flows through the VDD pin ($I_{DD}$) under the set conditions of $V1 = 3.4$ V, $V2 = V5 = V6 = 0$ V.

9. Current consumption during power-down, current consumption during overdischarge
   (Test circuit 3)
   9.1 With power-down function
   The current consumption during power-down ($I_{PDN}$) is $I_{DD}$ under the set conditions of $V1 = V2 = V6 = 1.5$ V, $V5 = 0$ V.
   9.2 Without power-down function
   The current consumption during overdischarge ($I_{OPEd}$) is $I_{DD}$ under the set conditions of $V1 = V2 = V6 = 1.5$ V, $V5 = 0$ V.

10. Resistance between VDD pin and VMC pin
    (Test circuit 3)
    $R_{VMCD}$ is the resistance between VDD pin and VMC pin under the set conditions of $V1 = 1.8$ V, $V2 = V5 = V6 = 0$ V.

11. Resistance between VDD pin and VMD pin
    (Test circuit 3)
    $R_{VMDD}$ is the resistance between VDD pin and VMD pin under the set conditions of $V1 = 1.8$ V, $V2 = V5 = V6 = 0$ V.

12. Resistance between VMD pin and VSS pin
    (Test circuit 3)
    $R_{VMDS}$ is the resistance between VMD pin and VSS pin when the voltage $V5$ is decreased to 0 V after setting $V1 = 3.4$ V, $V2 = 0$ V, $V5 = V6 = 1.0$ V.

13. CO pin resistance "H"
    (Test circuit 4)
    The CO pin resistance "H" ($R_{COH}$) is the resistance between VDD pin and CO pin under the set conditions of $V1 = 3.4$ V, $V2 = V5 = 0$ V, $V3 = 3.0$ V.

14. CO pin resistance "L"
    (Test circuit 4)
    The CO pin resistance "L" ($R_{COL}$) is the resistance between VMC pin and CO pin under the set conditions of $V1 = 4.7$ V, $V2 = V5 = 0$ V, $V3 = 0.4$ V.

15. DO pin resistance "H"
    (Test circuit 4)
    The DO pin resistance "H" ($R_{DOH}$) is the resistance between VDD pin and DO pin under the set conditions of $V1 = 3.4$ V, $V2 = V5 = 0$ V, $V4 = 3.0$ V.
16. DO pin resistance "L"  
(Test circuit 4)  
The DO pin resistance "L" (R_{DO}) is the resistance between VSS pin and DO pin under the set conditions of V1 = 1.8 V, V2 = V5 = 0 V, V4 = 0.4 V.

17. Overcharge detection delay time  
(Test circuit 5)  
After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, the voltage V1 is increased. The time interval from when the voltage V1 exceeds V_{CU} until V_{DO} goes to "L" is the overcharge detection delay time (t_{CU}).

18. Overdischarge detection delay time  
(Test circuit 5)  
After setting V1 = 3.4 V, V2 = V5 = V6 = 0 V, the voltage V1 is decreased. The time interval from when the voltage V1 falls below V_{DL} until V_{DO} goes to "L" is the overdischarge detection delay time (t_{DL}).

19. Discharge overcurrent detection delay time 1  
(Test circuit 5)  
After setting V1 = 3.4 V, V2 = V5 = 0 V, V6 = 1.4 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds V_{DIOV1} until V_{DO} goes to "L" is the discharge overcurrent detection delay time 1 (t_{DIOV1}).

20. Discharge overcurrent detection delay time 2  
(Test circuit 5)  
After setting V1 = 3.4 V, V2 = V5 = 0 V, V6 = 1.4 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds V_{DIOV2} until V_{DO} goes to "L" is the discharge overcurrent detection delay time 2 (t_{DIOV2}).

21. Load short-circuiting detection delay time  
(Test circuit 5)  
After setting V1 = 3.4 V, V2 = V5 = 0 V, V6 = 1.4 V, the voltage V5 is increased. The time interval from when the voltage V5 exceeds V_{SHORT} until V_{DO} goes to "L" is the load short-circuiting detection delay time (t_{SHORT}).

22. Charge overcurrent detection delay time  
(Test circuit 5)  
After setting V1 = 3.4 V, V2 = V5 = 0 V, the voltage V2 is decreased. The time interval from when the voltage V2 falls below V_{CIOV} until V_{CO} goes to "L" is the charge overcurrent detection delay time (t_{CIOV}).

23. 0 V battery charge starting charger voltage (0 V battery charge function "available")  
(Test circuit 4)  
The 0 V battery charge starting charger voltage (V_{COHA}) is defined as the absolute value of voltage V2 at which the current flowing through the CO pin (I_{CO}) exceeds 1.0 \mu A when the voltage V2 is gradually decreased after setting V1 = V5 = 0 V, V2 = V3 = -0.5 V.

24. 0 V battery charge inhibition battery voltage (0 V battery charge function "unavailable")  
(Test circuit 2)  
The 0 V battery charge inhibition battery voltage (V_{INH}) is defined as the voltage V1 at which V_{CO} goes to "L" (V_{CO} = V_{VMC}) when the voltage V1 is gradually decreased after setting V1 = 1.8 V, V2 = -2.0 V, V5 = V6 = 0 V.
CHARGE-DISCHARGE CURRENT PATH SEPARATION CIRCUIT COMPATIBLE BATTERY PROTECTION IC FOR 1-CELL PACK

S-82G1B Series

Rev.1.0.00

Figure 3  Test Circuit 1

Figure 4  Test Circuit 2

Figure 5  Test Circuit 3

Figure 6  Test Circuit 4

Figure 7  Test Circuit 5
### Operation

**Remark** Refer to "Battery Protection IC Connection Example".

1. **Normal status**

   The S-82G1B Series monitors the voltage of the battery connected between VDD pin and VSS pin, the voltage between VINI pin and VSS pin and the voltage between VMC pin and VSS pin to control charging and discharging. When the battery voltage is in the range from overdischarge detection voltage ($V_{DL}$) to overcharge detection voltage ($V_{CU}$), the VINI pin voltage is equal to or lower than the discharge overcurrent detection voltage 1 ($V_{DIOV1}$), the VMC pin voltage is equal to or higher than the charge overcurrent detection voltage ($V_{CIOV}$), the S-82G1B Series turns both the charge and discharge control FETs on. This condition is called the normal status, and in this condition charging and discharging can be carried out freely.

   The resistance between VDD pin and VMC pin ($R_{VMCD}$), the resistance between VDD pin and VMD pin ($R_{VMDD}$), and the resistance between VMD pin and VSS pin ($R_{VMDS}$) are not connected in the normal status.

2. **Overcharge status**

   2.1 $V_{CL} \neq V_{CU}$ (Product in which overcharge release voltage differs from overcharge detection voltage)

   When the battery voltage becomes higher than $V_{CU}$ during charging in the normal status and the condition continues for the overcharge detection delay time ($t_{CU}$) or longer, the S-82G1B Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

   The overcharge status is released in the following two cases.

   (1) In the case that the VMC pin voltage is lower than 0.35 V typ., the S-82G1B Series releases the overcharge status when the battery voltage falls below overcharge release voltage ($V_{CL}$).

   (2) In the case that the VMC pin voltage is equal to or higher than 0.35 V typ., the S-82G1B Series releases the overcharge status when the battery voltage falls below $V_{CU}$.

   Even if the battery voltage exceeds $V_{CU}$, discharge overcurrent detection and load short-circuiting detection will function.

   **Caution** If the battery is charged to a voltage higher than $V_{CU}$ and the battery voltage does not fall below $V_{CU}$ even when a load is erroneously connected to the CHA− pin, the discharge current will continue to flow until the battery voltage falls below $V_{CU}$.

   2.2 $V_{CL} = V_{CU}$ (Product in which overcharge release voltage is the same as overcharge detection voltage)

   When the battery voltage becomes higher than $V_{CU}$ during charging in the normal status and the condition continues for $t_{CU}$ or longer, the S-82G1B Series turns the charge control FET off to stop charging. This condition is called the overcharge status.

   In the case that the VMC pin voltage is equal to or higher than 0 V typ. and the battery voltage falls below $V_{CU}$, the S-82G1B Series releases the overcharge status.

   Even if the battery voltage exceeds $V_{CU}$, discharge overcurrent detection and load short-circuiting detection will function.

   **Caution** 1. If the battery is charged to a voltage higher than $V_{CU}$ and the battery voltage does not fall below $V_{CU}$ even when a load is erroneously connected to the CHA− pin, the discharge current will continue to flow until the battery voltage falls below $V_{CU}$.

   2. When a charger is connected after overcharge detection, the overcharge status is not released even if the battery voltage is below $V_{CL}$. The overcharge status is released when the VMC pin voltage goes over 0 V typ. by removing the charger.
3. Overdischarge status

When the battery voltage falls below $V_{DL}$ during discharging in the normal status and the condition continues for the overdischarge detection delay time ($t_{DL}$) or longer, the S-82G1B Series turns the discharge control FET off to stop discharging. This condition is called the overdischarge status.

Under the overdischarge status, the VDD pin and VMC pin are shorted by $R_{VMCD}$, and the VDD pin and VMD pin are shorted by $R_{VMDD}$ in the S-82G1B Series. The VMC pin and VMD pin voltages are pulled up by $R_{VMCD}$ and $R_{VMDD}$ respectively.

When connecting a charger in the overdischarge status, the battery voltage reaches $V_{DL}$ or higher and the S-82G1B Series releases the overdischarge status if the VMC pin voltage falls below 0 V typ.

The battery voltage reaches the overdischarge release voltage ($V_{DU}$) or higher and the S-82G1B Series releases the overdischarge status if the VMC pin voltage does not fall below 0 V typ. $R_{VMDS}$ is not connected in the overdischarge status.

3.1 With power-down function

Under the overdischarge status, when voltage difference between VDD pin and VMC pin is 0.8 V typ. or lower, the power-down function works and the current consumption is reduced to the current consumption during power-down ($I_{PDN}$). By connecting a battery charger, the power-down function is released when the VMC pin voltage is 0.7 V typ. or lower.

- When a battery is not connected to a charger and the VMC pin voltage $\geq 0.7$ V typ., the S-82G1B Series maintains the overdischarge status even when the battery voltage reaches $V_{DU}$ or higher.
- When a battery is connected to a charger and 0.7 V typ. $> V_{MC}$ pin voltage $> 0$ V typ., the battery voltage reaches $V_{DU}$ or higher and the S-82G1B Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. $\geq V_{MC}$ pin voltage, the battery voltage reaches $V_{DL}$ or higher and the S-82G1B Series releases the overdischarge status.

3.2 Without power-down function

Under the overdischarge status, the power-down function does not work even when voltage difference between VDD pin and VMC pin is 0.8 V typ. or lower.

- When a battery is not connected to a charger and the VMC pin voltage $\geq 0.7$ V typ., the battery voltage reaches $V_{DU}$ or higher and the S-82G1B Series releases the overdischarge status.
- When a battery is connected to a charger and 0.7 V typ. $> V_{MC}$ pin voltage $> 0$ V typ., the battery voltage reaches $V_{DU}$ or higher and the S-82G1B Series releases the overdischarge status.
- When a battery is connected to a charger and 0 V typ. $\geq V_{MC}$ pin voltage, the battery voltage reaches $V_{DL}$ or higher and the S-82G1B Series releases the overdischarge status.
4. Discharge overcurrent status (Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting, load short-circuiting 2)

4.1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting

When a battery in the normal status or the overcharge status is in the status where the VINI pin voltage is equal to or higher than $V_{DI0V1}$ because the discharge current is equal to or higher than the specified value and the status lasts for the discharge overcurrent detection delay time $t_{DI0V1}$ or longer, the discharge control FET is turned off and discharging is stopped. This status is called the discharge overcurrent status.

Under the discharge overcurrent status, VMD pin and VSS pin are shorted by $R_{VMDS}$ in the S-82G1B Series. However, the VMD pin voltage is the VDD pin voltage due to the load as long as the load is connected. When the load is disconnected, VMD pin voltage returns to the VSS pin voltage.

When the VMD pin voltage returns to $V_{ROV}$ or lower, the S-82G1B Series releases the discharge overcurrent status.

$R_{VMDD}$ is not connected in the discharge overcurrent status.

4.2 Load short-circuiting 2

When a battery in the normal status or the overcharge status is in the status where a load causing discharge overcurrent is connected, and the VMD pin voltage is equal to or higher than $V_{SHORT2}$ and the status lasts for the load short-circuiting detection delay time $t_{SHORT}$ or longer, the discharge control FET is turned off and discharging is stopped. The S-82G1B Series then becomes discharge overcurrent status.

The S-82G1B Series releases the discharge overcurrent status in the same way as in "4.1 Discharge overcurrent 1, discharge overcurrent 2, load short-circuiting".

5. Charge overcurrent status

When a battery in the normal status is in the status where the VMC pin voltage is equal to or lower than $V_{CIOV}$ because the charge current is equal to or higher than the specified value and the status lasts for the charge overcurrent detection delay time $t_{CIOV}$ or longer, the charge control FET is turned off and charging is stopped. This status is called the charge overcurrent status.

The charge overcurrent status is released when the VMC pin voltage goes over 0 V typ. by removing the charger.

The charge overcurrent detection does not function in the overdischarge status.

6. Discharge current stop function in charge current path

When the discharge current flows to charge current path because a load is erroneously connected to a charge pin in a battery in the normal status, and the time at which the VMC pin voltage is equal to or higher than 7 mV typ. lasts for the load short-circuiting detection delay time $t_{SHORT}$ or longer, the discharge current is stopped by changing the gate potential of charge control FET to the $V_{SS}$ potential.

In this status, the VDD pin and VMC pin are shorted by $R_{VMCD}$ in the S-82G1B Series. The VMC pin voltage is pulled up by $R_{VMCD}$.

The S-82G1B Series returns to the normal status once the VMC pin voltage falls below 7 mV typ. by disconnecting a load and connecting a charger.
7. 0 V battery charge function "available"

This function is used to recharge a connected battery whose voltage is 0 V due to self-discharge. When the 0 V battery charge starting charger voltage ($V_{CHA}$) or a higher voltage is applied between the EB+ and CHA− pins by connecting a charger, the charge control FET gate is fixed to the VDD pin voltage. When the voltage between the gate and source of the charge control FET becomes equal to or higher than the threshold voltage due to the charger voltage, the charge control FET is turned on to start charging. At this time, the discharge control FET is off and the charging current flows through the internal parasitic diode in the discharge control FET. When the battery voltage becomes equal to or higher than $V_{DL}$, the S-82G1B Series returns to the normal status.

Caution
1. Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge function.

2. The 0 V battery charge function has higher priority than the charge overcurrent detection function. Consequently, a product in which use of the 0 V battery charge function is enabled charges a battery forcibly and the charge overcurrent cannot be detected when the battery voltage is lower than $V_{DL}$.

8. 0 V battery charge function "unavailable"

This function inhibits charging when a battery that is internally short-circuited (0 V battery) is connected. When the battery voltage is the 0 V battery charge inhibition battery voltage ($V_{OINH}$) or lower, the charge control FET gate is fixed to the CHA− pin voltage to inhibit charging. When the battery voltage is $V_{OINH}$ or higher, charging can be performed.

Caution
Some battery providers do not recommend charging for a completely self-discharged lithium-ion rechargeable battery. Please ask the battery provider to determine whether to enable or inhibit the 0 V battery charge function.

9. Delay circuit

The detection delay times are determined by dividing a clock of approximately 4 kHz by the counter.

**Remark** $t_{DIOV1}$, $t_{DIOV2}$ and $t_{SHORT}$ start when $V_{DIOV1}$ is detected. When $V_{DIOV2}$ or $V_{SHORT}$ is detected over $t_{DIOV2}$ or $t_{SHORT}$ after the detection of $V_{DIOV1}$, the S-82G1B Series turns the discharge control FET off within $t_{DIOV2}$ or $t_{SHORT}$ of each detection.
### Timing Charts

1. Overcharge detection, overdischarge detection

![Timing Chart Diagram]

- **Battery voltage**
  - \( V_{CU} \)
  - \( V_{CL} (V_{CU} - V_{HC}) \)
- **DO pin voltage**
  - \( V_{DO} \)
- **CO pin voltage**
  - \( V_{SS} \)
  - \( V_{CHAO} \)
- **VMC pin voltage**
  - \( V_{SS} \)
  - \( V_{CHAO} \)
- **VMD pin voltage**
  - \( V_{DOV1} \)
  - \( V_{SS} \)

**Charger connection**

**Load connection**

- Overcharge detection delay time (\( t_{CU} \))
- Overdischarge detection delay time (\( t_{DL} \))

*1. (1) : Normal status
(2) : Overcharge status
(3) : Overdischarge status

**Remark** The charger is assumed to charge with a constant current.

**Figure 9**
2. Discharge overcurrent detection

- **Battery voltage**
  - $V_{CL} (V_{CU} - V_{HC})$

- **DO pin voltage**
  - $V_D$

- **CO pin voltage**
  - $V_S$

- **VMD pin voltage**
  - $V_{RD}$

- **VINI pin voltage**
  - $V_{SH}$

*1. (1) : Normal status
   (2) : Discharge overcurrent status

**Remark** The charger is assumed to charge with a constant current.

Figure 10
3. Charge overcurrent detection

**Figure 11**

*1. (1) : Normal status  
(2) : Charge overcurrent status  
(3) : Overdischarge status

Remark The charger is assumed to charge with a constant current.
### Battery Protection IC Connection Example

![Diagram of Battery Protection IC Connection Example]

#### Table 10 Constants for External Components

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Part</th>
<th>Purpose</th>
<th>Min.</th>
<th>Typ.</th>
<th>Max.</th>
<th>Remark</th>
</tr>
</thead>
<tbody>
<tr>
<td>FET1</td>
<td>N-channel MOS FET</td>
<td>Charge control</td>
<td>–</td>
<td>–</td>
<td>–</td>
<td>Threshold voltage ( \leq ) Overdischarge detection voltage *1</td>
</tr>
<tr>
<td>FET2</td>
<td>N-channel MOS FET</td>
<td>Charge control</td>
<td>–</td>
<td>–</td>
<td>–</td>
<td>Threshold voltage ( \leq ) Overdischarge detection voltage *1</td>
</tr>
<tr>
<td>FET3</td>
<td>N-channel MOS FET</td>
<td>Discharge control</td>
<td>–</td>
<td>–</td>
<td>–</td>
<td>Threshold voltage ( \leq ) Overdischarge detection voltage *1</td>
</tr>
<tr>
<td>R1</td>
<td>Resistor</td>
<td>ESD protection, protection for power fluctuation</td>
<td>270 Ω</td>
<td>330 Ω</td>
<td>1.2 kΩ *2</td>
<td>–</td>
</tr>
<tr>
<td>C1</td>
<td>Capacitor</td>
<td>Protection for power fluctuation</td>
<td>0.068 μF</td>
<td>0.1 μF</td>
<td>2.2 μF</td>
<td>–</td>
</tr>
<tr>
<td>R2</td>
<td>Resistor</td>
<td>ESD protection, Protection for reverse connection of a charger</td>
<td>300 Ω</td>
<td>470 Ω</td>
<td>1.5 kΩ</td>
<td>–</td>
</tr>
<tr>
<td>R3</td>
<td>Resistor</td>
<td>ESD protection, Protection for reverse connection of a charger</td>
<td>300 Ω</td>
<td>470 Ω</td>
<td>1.5 kΩ</td>
<td>–</td>
</tr>
<tr>
<td>R4</td>
<td>Resistor</td>
<td>Discharge overcurrent detection</td>
<td>–</td>
<td>3 mΩ</td>
<td>–</td>
<td>–</td>
</tr>
</tbody>
</table>

*1. If a FET with a threshold voltage equal to or higher than the overdischarge detection voltage is used, discharging may be stopped before overdischarge is detected.

*2. Accuracy of overcharge detection voltage is guaranteed by \( R_1 = 330 \) Ω. Connecting resistors with other values will worsen the accuracy.

**Caution 1.** The above constants may be changed without notice.

2. It has not been confirmed whether the operation is normal or not in circuits other than the above example of connection. In addition, the example of connection shown above and the constants do not guarantee proper operation. Perform thorough evaluation using the actual application to set the constants.
Precautions

- The application conditions for the input voltage, output voltage, and load current should not exceed the power dissipation.

- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.

- ABLIC Inc., claims no responsibility for any and all disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.
Characteristics (Typical Data)

1. Current consumption

1. 1 $I_{\text{OPe}}$ vs. $T_a$

- $I_{\text{OPe}}$ vs. $T_a$

1. 2 $I_{\text{PDN}}$ vs. $T_a$

- $I_{\text{PDN}}$ vs. $T_a$

1. 3 $I_{\text{OPED}}$ vs. $T_a$

- $I_{\text{OPED}}$ vs. $T_a$

1. 4 $I_{\text{OPe}}$ vs. $V_{\text{DD}}$

1. 4. 1 With power-down function

- $I_{\text{OPe}}$ vs. $V_{\text{DD}}$ (With power-down function)

1. 4. 2 Without power-down function

- $I_{\text{OPe}}$ vs. $V_{\text{DD}}$ (Without power-down function)
2. Detection voltage

2.1 $V_{CU}$ vs. $T_a$

![Graph of $V_{CU}$ vs. $T_a$]

2.2 $V_{CL}$ vs. $T_a$

![Graph of $V_{CL}$ vs. $T_a$]

2.3 $V_{DL}$ vs. $T_a$

![Graph of $V_{DL}$ vs. $T_a$]

2.4 $V_{DU}$ vs. $T_a$

![Graph of $V_{DU}$ vs. $T_a$]

2.5 $V_{DIOV1}$ vs. $V_{DD}$

![Graph of $V_{DIOV1}$ vs. $V_{DD}$]

2.6 $V_{DIOV1}$ vs. $T_a$

![Graph of $V_{DIOV1}$ vs. $T_a$]

2.7 $V_{DIOV2}$ vs. $V_{DD}$

![Graph of $V_{DIOV2}$ vs. $V_{DD}$]

2.8 $V_{DIOV2}$ vs. $T_a$

![Graph of $V_{DIOV2}$ vs. $T_a$]
3. Delay time

3.1 $t_{CU}$ vs. $T_a$

3.2 $t_{DL}$ vs. $T_a$

3.3 $t_{DIOV1}$ vs. $V_{DD}$

3.4 $t_{DIOV1}$ vs. $T_a$

3.5 $t_{DIOV2}$ vs. $V_{DD}$

3.6 $t_{DIOV2}$ vs. $T_a$

3.7 $t_{SHORT}$ vs. $V_{DD}$

3.8 $t_{SHORT}$ vs. $T_a$
3.9 $t_{CIOV} - V_{DD}$

4.1 $R_{COH} vs. V_{CO}$

4.3 $R_{DOH} vs. V_{DO}$

4. Output resistance

4.2 $R_{COL} vs. V_{CO}$

4.4 $R_{DOL} vs. V_{DO}$
Marking Specifications

1. HSNT-8(1616)

<table>
<thead>
<tr>
<th>Top view</th>
</tr>
</thead>
<tbody>
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- (1): Blank
- (2) to (4): Product code (refer to Product name vs. Product code)
- (5) to (7): Lot number

<table>
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<tr>
<th>Product Name</th>
<th>Product Code</th>
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</thead>
<tbody>
<tr>
<td>S-82G1BAA-A8T2U</td>
<td>7 J R</td>
</tr>
</tbody>
</table>
**Power Dissipation**

**HSNT-8(1616)**

![Power Dissipation Graph]

- **Board** | **Power Dissipation (P_d)**
  - A     | 0.47 W
  - B     | 0.58 W
  - C     | –
  - D     | –
  - E     | –

$T_j = +125^\circ C \text{ max.}$
### (1) Board A

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<td>Size [mm]</td>
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<tr>
<td>Material</td>
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</tr>
<tr>
<td>Number of copper foil layer</td>
<td>2</td>
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<tr>
<td>Copper foil layer [mm]</td>
<td>1  Land pattern and wiring for testing: 0.070</td>
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<tr>
<td></td>
<td>2  -</td>
</tr>
<tr>
<td></td>
<td>3  -</td>
</tr>
<tr>
<td></td>
<td>4  74.2 x 74.2 x 0.070</td>
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<td>Thermal via</td>
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### (2) Board B

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<td>Number of copper foil layer</td>
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<td>Copper foil layer [mm]</td>
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<tr>
<td></td>
<td>2  74.2 x 74.2 x 0.035</td>
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<td></td>
<td>3  74.2 x 74.2 x 0.035</td>
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<tr>
<td></td>
<td>4  74.2 x 74.2 x 0.070</td>
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<tr>
<td>Thermal via</td>
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No. HSNT8-B-Board-SD-1.0

ABLIC Inc.
The heat sink of back side has different electric potential depending on the product. Confirm specifications of each product. Do not use it as the function of electrode.

No. PY008-A-P-SD-1.0

<table>
<thead>
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<th>TITLE</th>
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<tr>
<td>ANGLE</td>
<td>⌈主打平\⌉</td>
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ABLIC Inc.
Enlarged drawing in the central part

No. PY008-A-R-SD-1.0

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<tr>
<td>ANGLE</td>
<td>QTY. 5,000</td>
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<tr>
<td>UNIT</td>
<td>mm</td>
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</table>

ABLIC Inc.
### Land Pattern

![Land Pattern Diagram]

**Caution** It is recommended to solder the heat sink to a board in order to ensure the heat radiation.

注意 放熱性を確保する為に、PKGの裏面放熱板（ヒートシンク）基板に半田付けする事を推奨いたします。

### Metal Mask Pattern

![Metal Mask Pattern Diagram]

**Caution**

① Mask aperture ratio of the lead mounting part is 100%.
② Mask aperture ratio of the heat sink mounting part is 40%.
③ Mask thickness: 10.12 mm

注意 ①リード実装部のマスク開口率は100%です。
②放熱板実装のマスク開口率は40%です。
③マスク厚み：10.12 mm

<table>
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<th>TITLE</th>
<th>HSNT-8-B -Land Recommendation</th>
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<tr>
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</table>

No. PY008-A-L-SD-1.0

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The entire system must be sufficiently evaluated and applied on customer’s own responsibility.

10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.

11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.

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2.2-2018.06